

FORM PTO-1449
(REV. 7-80)U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICEATTY. DOCKET NO.
501298.02APPLICATION NO.
10/666,393

INFORMATION DISCLOSURE STATEMENT

(Use several sheets if necessary)

APPLICANT(S)

Philip Neaves

FILING DATE

September 17, 2003

GROUP ART UNIT

2812

U.S. PATENT DOCUMENTS

EXAMINER	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
W	AA 5,786,979	07/28/98	Douglass	361	328	
	AB 5,818,112	10/06/98	Weber et al.	257	777	
	AC 6,496,889 B1	12/17/02	Perino et al.	710	110	
	AD 6,500,696 B2	12/31/02	Sutherland	438	109	
W	AE 2001/0039075 A1	11/08/01	Doyle et al.	438	107	
	AF					
	AG					
	AH					
	AI					
	AJ					

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
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OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)

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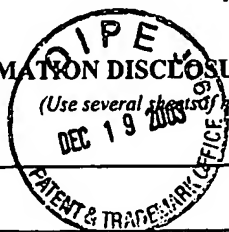
3/11/05

* EXAMINER: Initial if reference considered, whether or not criteria is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).

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Not Yet Assigned

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
le	AA	5,673,130	09/30/97	Sundstrom et al.	359	158	
	AB	6,310,494 B1	10/30/01	Ehben et al.	326	82	
de	AC	6,425,107 B1	07/23/02	Caldara et al.	714	759	
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
le	AK	0366263 A3	05/02/90	EP			X	
u	AL	WO 0215185 A1	02/21/02	PCT			X	
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lu	AA	6,188,232 B1	02/13/01	Akram et al.	324	755	
	AB	6,285,201 B1	09/04/01	Farnworth et al.	324	755	
	AC	6,357,025 B1	03/12/02	Tuttle	714	724	
	AD	6,368,930 B1	04/09/02	Enquist	438	320	
	AE	6,396,292 B2	05/28/02	Hembree et al.	324	755	
	AF	6,407,566 B1	06/18/02	Brunelle et al.	324	758	
	AG	6,490,188 B2	12/03/02	Nuxoll et al.	365	63	
	AH	6,563,133 B1	05/13/03	Tong	257	52	
	AI	6,563,299 B1	05/13/03	Van Horn et al.	324	158.1	
	AJ	6,620,638 B1	09/16/03	Farrar	438	14	
lu	AK	6,625,073 B1	09/23/03	Beffa	365	201	
	AL	2001/0054908 A1	12/27/01	Farnworth et al.	324	755	
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FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
lu	AP	0 277 764 A3	01/27/88	EP			X	
	AQ	0 492 806 A3	11/26/91	EP			X	
	AR	0 805 356 A3	04/22/98	EP			X	
	AS	2 353 401 A	02/21/01	GB			X	
lu	AT	2 353 402 A	02/21/01	GB			X	
	AU						X	
	AV							

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OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)					
Le	AW	"International Technology Roadmap for Semiconductors", Assembly and Packaging, 2001, pp. 1-21.			
	AX	Karnezos, M. et al., "System in a Package (SiP) Benefits and Technical Issues", in <i>Proceedings of APEX</i> , San Diego, California, 2002, 7 pages.			
	AY	Mick, S. et al., "4Gbps High-Density AC Coupled Interconnection", Department of Electrical and Computer Engineering North Carolina State University, IEEE Custom Integrated Circuits Conference, May 12-16, 2002, pp. 133-140.			
	AZ	"Rapidly Advancing System-in-Package Fabrication Technology", Vol. 20, No.3, 2002, pp. 3-11.			
	BA	Scanlan, C.M. et al., "System-In-Package Technology, Application and Trends", 2001 Proceedings of SMTA International, Rosemont, Illinois, pp. 764-773.			
Lu	BB	Wang, M. et al., "Configurable Area-IO Memory for System-In-A-Package (SiP)", 27 th European Solid-State Circuits Conference, September, 2001, 4 pages.			
	BC				
	BD				
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